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(54) **DISPLAY MODULE AND DISPLAY APPARATUS**

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(71) Applicants: **BOE TECHNOLOGY GROUP CO., LTD.**, Beijing (CN); **Yunnan Invensight Optoelectronics Technology Co., Ltd.**, Kunming, Yunnan (CN)

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(72) Inventors: **Chao PU**, Beijing (CN); **Shengji YANG**, Beijing (CN); **Kuanta HUANG**, Beijing (CN); **Pengcheng LU**, Beijing (CN); **Xiaochuan CHEN**, Beijing (CN)

(57)

**ABSTRACT**

A display module has a bonding region, and includes a first bonding component and a second bonding component. The first bonding component includes first test pins and first function pins that are disposed in the bonding region and arranged in a first direction. The second bonding component includes second test pins and second function pins that are disposed in the bonding region and arranged in the first direction. The second test pins and the first test pins are coupled to constitute test pin pairs, the second function pins and the first function pins are coupled to constitute function pin pairs, and the test pin pairs and the function pin pairs constitute a pin row. The first bonding component further includes at least one first dummy pin disposed in the bonding region, and a first dummy pin is located on an outer side of the pin row in the first direction.

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